

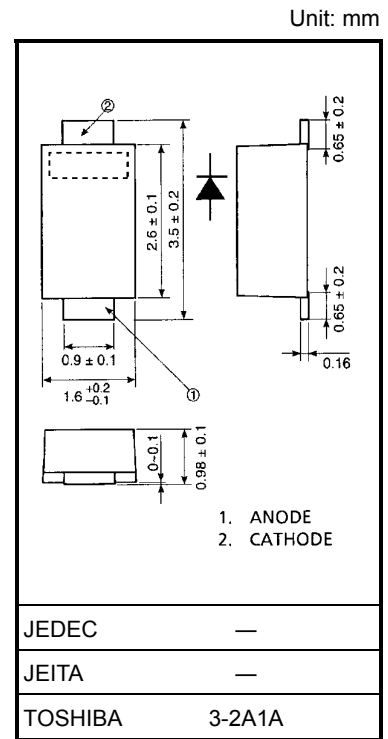
CRH01

Switching Mode Power Supply Applications

- Repetitive peak reverse voltage: $V_{RRM} = 200\text{ V}$
- Average forward current: $I_F(AV) = 1.0\text{ A}$
- Low forward voltage: $V_{FM} = 0.98\text{ V (Max.)}$
- Very Fast Reverse-Recovery Time: $t_{rr} = 35\text{ ns (Max.)}$
- Suitable for compact assembly due to small surface-mount package
“S-FLAT™” (Toshiba package name)

Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Rating	Unit
Repetitive peak reverse voltage	V_{RRM}	200	V
Average forward current	$I_{F(AV)}$	1.0	A
Peak one cycle surge forward current (non-repetitive)	I_{FSM}	15 (50 Hz)	A
Junction temperature	T_j	$-40\sim 150$	$^\circ\text{C}$
Storage temperature range	T_{stg}	$-40\sim 150$	$^\circ\text{C}$



Weight: 0.013 g (typ.)

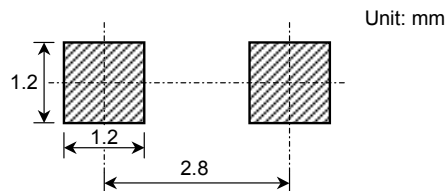
Electrical Characteristics ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Peak forward voltage	$V_{FM(1)}$	$I_{FM} = 0.1\text{ A}$	—	0.71	—	V
	$V_{FM(2)}$	$I_{FM} = 0.7\text{ A}$	—	0.86	—	
	$V_{FM(3)}$	$I_{FM} = 1.0\text{ A}$	—	0.90	0.98	
Repetitive peak reverse current	I_{RRM}	$V_{RRM} = 200\text{ V}$	—	—	10	μA
Reverse recovery time	t_{rr}	$I_F = 1\text{ A}$, $di/dt = -30\text{ A}/\mu\text{s}$	—	—	35	ns
Forward recovery time	t_{fr}	$I_F = 1\text{ A}$	—	—	100	ns
Thermal resistance	$R_{th(j-a)}$	Device mounted on a ceramic board (soldering land: 2 mm × 2 mm)	—	—	65	$^\circ\text{C/W}$
		Device mounted on a glass-epoxy board (soldering land: 6 mm × 6 mm)	—	—	130	

Marking

Abbreviation Code	Part No.
H1	CRH01

Standard Soldering Pad



Handling Precaution

The maximum ratings denote the absolute maximum ratings, which are rated values and must not be exceeded during operation, even for an instant. The following are the general derating methods that we recommend when you design a circuit with a device.

VRRM: We recommend that the worst case voltage, including surge voltage, be no greater than 80% of the maximum rating of VRRM for a DC circuit and be no greater than 50% of that of VRRM for an AC circuit. VRRM has a temperature coefficient of 0.1%/°C. Take this temperature coefficient into account designing a device at low temperature.

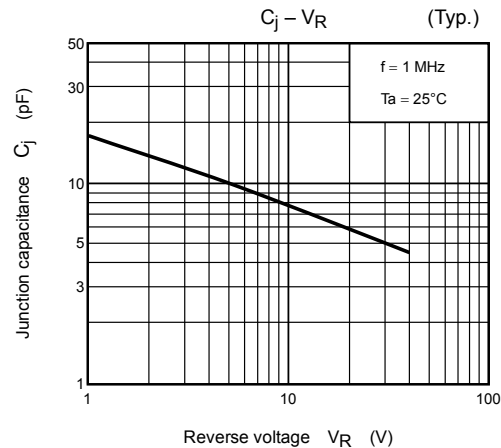
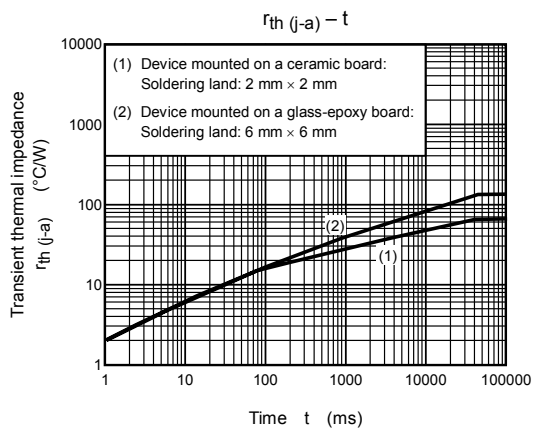
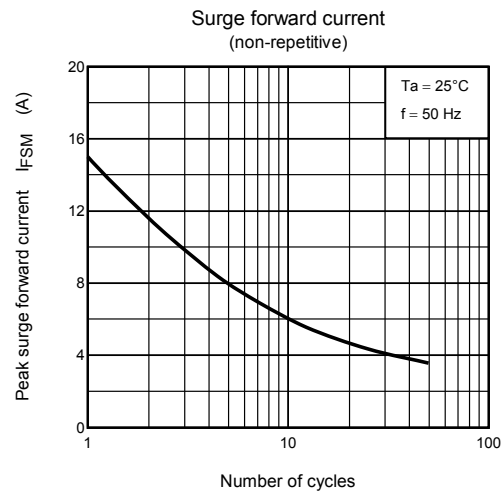
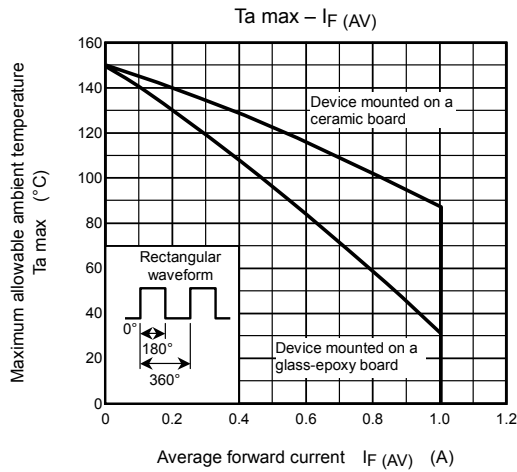
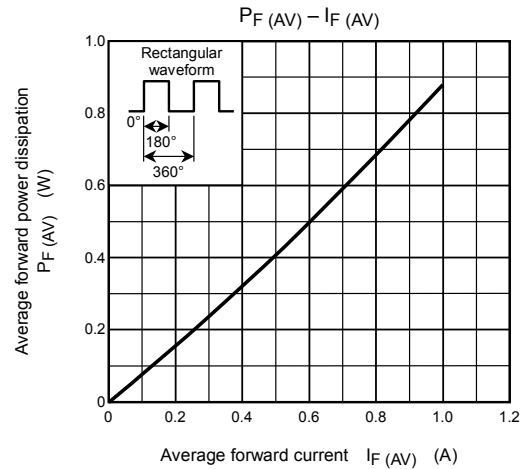
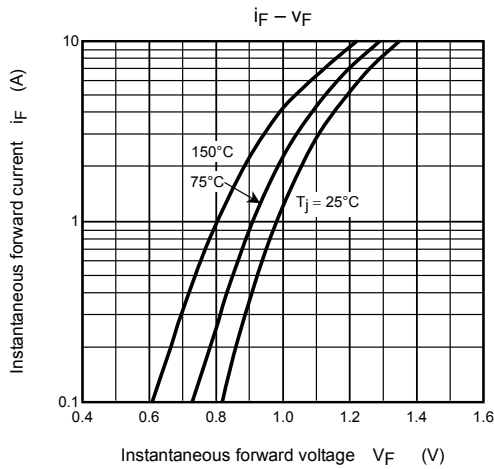
IF(AV): We recommend that the worst case current be no greater than 80% of the maximum rating of IF(AV). Carry out adequate heat design. If you can't design a circuit with excellent heat radiation, set the margin by using an allowable T_{max} -IF(AV) curve.

This rating specifies the non-repetitive peak current in one cycle of a 50-Hz sine wave, condition angle 180. Therefore, this is only applied for an abnormal operation, which seldom occurs during the lifespan of the device.

We recommend that a device be used at a T_j of below 120°C under the worst load and heat radiation conditions.

Thermal resistance between junction and ambient fluctuates depending on the device's mounting condition. When using a device, design a circuit board and a soldering land size to match the appropriate thermal resistance value.

Please refer to the Rectifiers databook for further information.



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